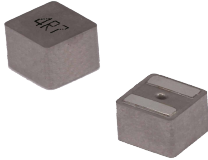


## MDTE Series

### Wire Wound Molded SMD Power Inductors

#### Size 1510



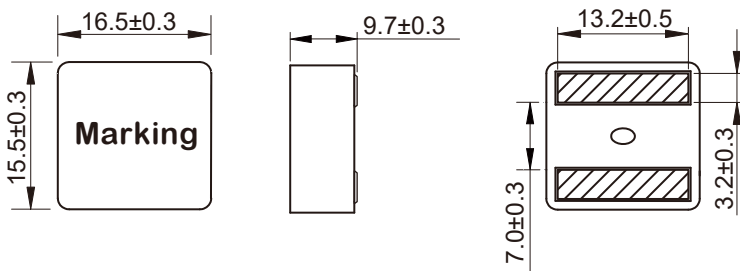
#### FEATURES

- Soft saturation
- High current, low DCR, high efficiency
- Very low acoustic noise and very low leakage flux noise
- High reliability
- 100% Lead(Pb)-Free and RoHS compliant
- Operating temperature -55~+125 °C (Including self - temperature rise)
- Quantity: 150pcs

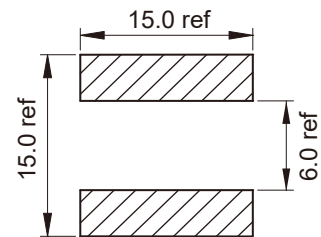
#### APPLICATION

- Note PC power system, incl. IMVP-6
- DC/DC converter

#### Dimensions: [mm]



#### Land Pattern: [mm]



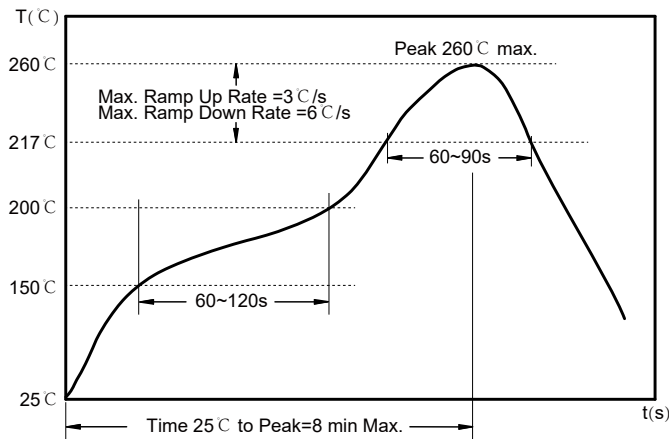
#### Electrical Properties:

Part No	Inductance @ 100KHz/0.1V ( $\mu$ H)	Tolerance	Saturation Current Typ. (A)	Saturation Current Max. (A)	Temperature Rise Current Typ. (A)	DC Resistance Max. (m $\Omega$ )
MDTE1510-4R7M	4.7	±20%	43.0	39.0	30.0	3.8
MDTE1510-5R6M	5.6	±20%	38.0	34.0	28.0	4.2
MDTE1510-6R8M	6.8	±20%	36.0	31.0	26.0	4.6
MDTE1510-8R2M	8.2	±20%	32.0	28.0	25.0	7.2
MDTE1510-100M	10	±20%	29.0	26.0	24.0	8.6
MDTE1510-150M	15	±20%	20.0	18.0	18.0	11.5
MDTE1510-220M	22	±20%	18.0	16.0	14.2	15.8
MDTE1510-330M	33	±20%	16.7	14.0	12.3	20.0

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is  $\Delta T=40^{\circ}\text{C}$

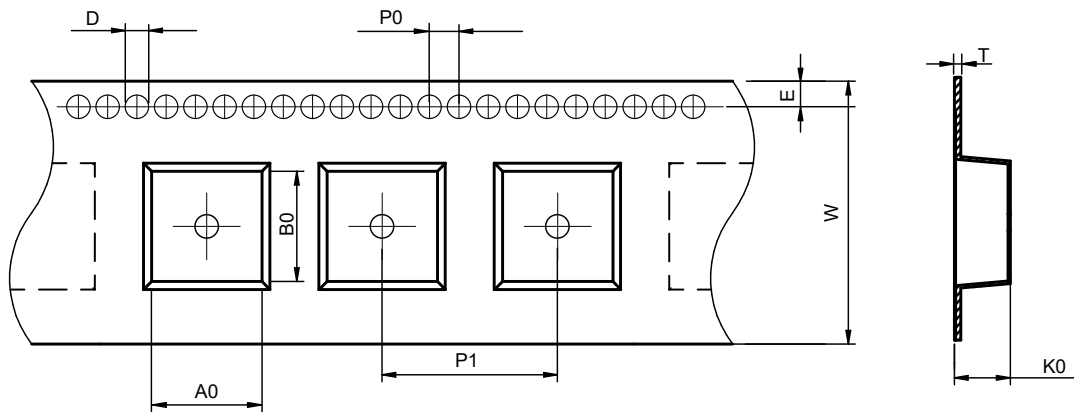
### Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.  
 Allowed time above 217 °C: 60~90 sec.  
 Max temperature: 260 °C.  
 Max time at max temperature: 10 sec.  
 Allowed Reflow time: 2x max.

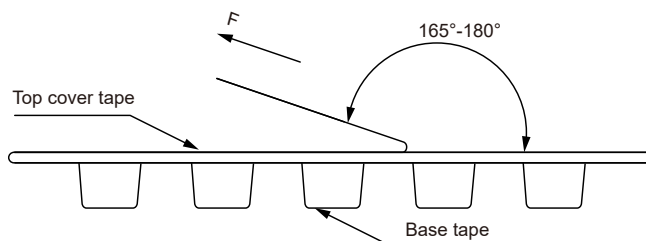
### Packaging Information:

#### Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE1510	17.0±0.1	16.0±0.1	1.5±0.1	4.0±0.1	24.0±0.1	32.0±0.3	10.5±0.1	1.75±0.1	0.5±0.05

#### Peel force of top cover tape:

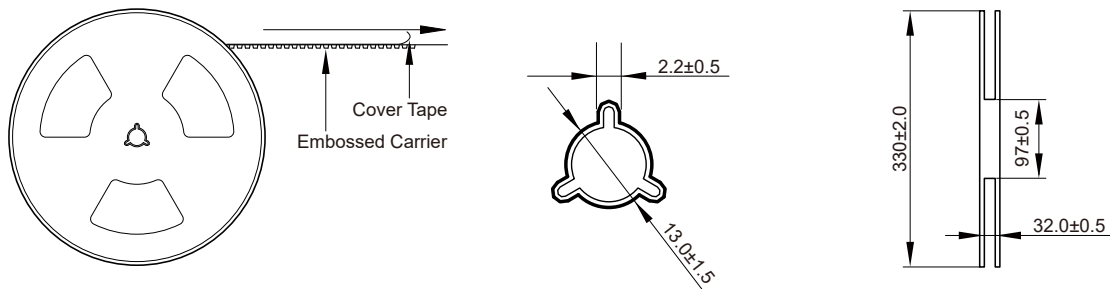


The peel force of top cover tape shall be between 0.1 to 1.3 N

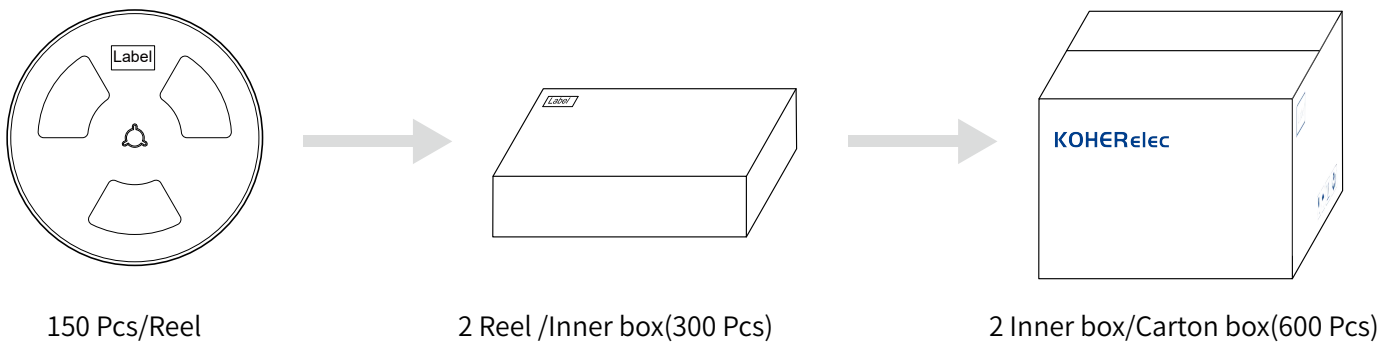
#### Product Marking:

Marking	Printing (Inductance)
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Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions :

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max).If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components.The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does.As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.